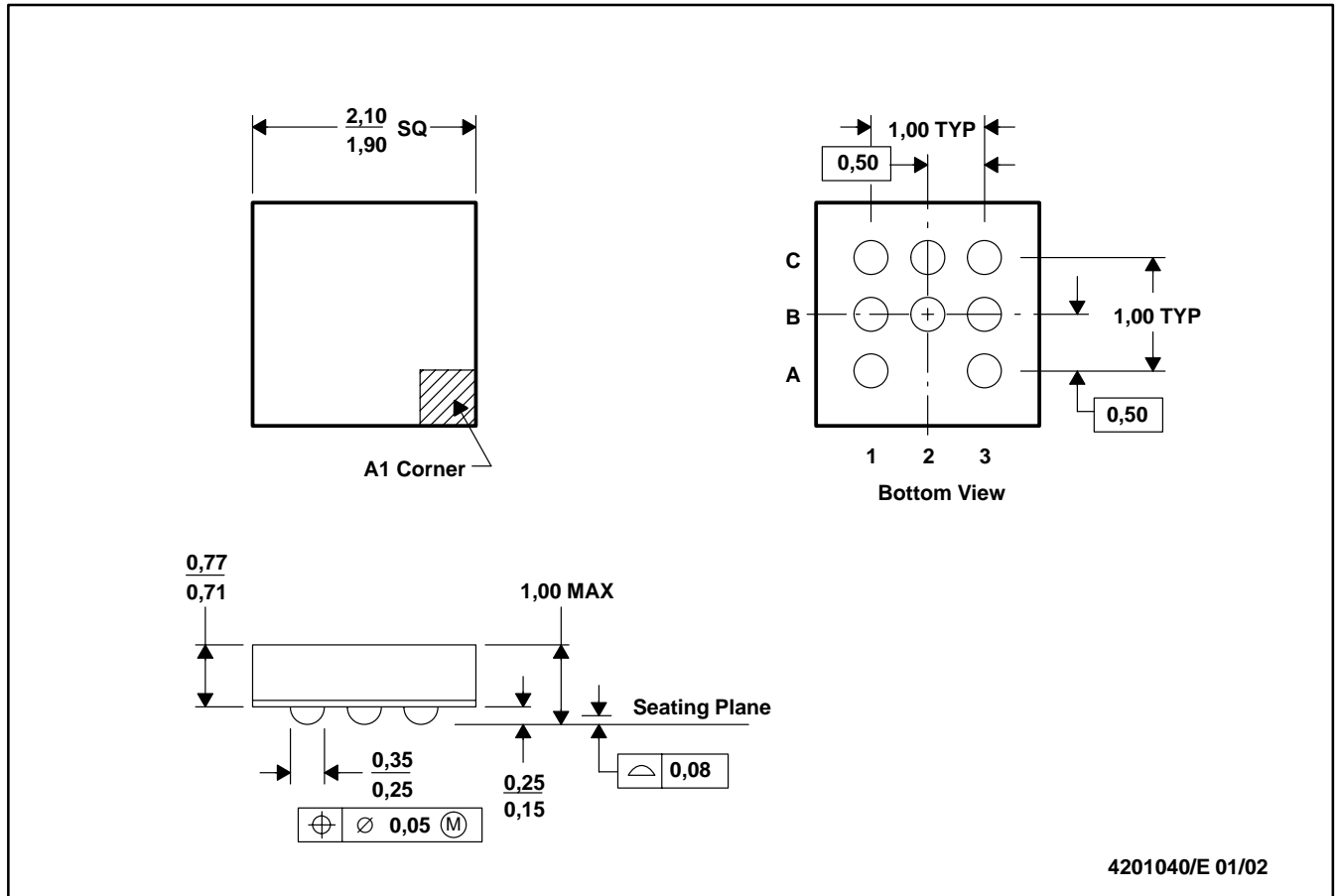


GQV (S-PBGA-N8)

PLASTIC BALL GRID ARRAY



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. MicroStar Junior™ configuration  
 D. Falls within JEDEC MO-225

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